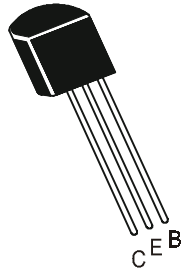


NPN SILICON PLANAR EPITAXIAL RF TRANSISTORS

**BF494
 BF495**



**TO-92
 Plastic Package**

High Voltage Video Transistors

ABSOLUTE MAXIMUM RATINGS(Ta=25°C unless specified otherwise)

DESCRIPTION	SYMBOL	Value	UNITS
Collector Emitter Voltage	V_{CEO}	20	V
Collector Base Voltage	V_{CBO}	30	V
Emitter Base Voltage	V_{EBO}	5	V
Collector Current (DC)	I_C	30	mA
Collector Current(peak value)	I_{CM}	30	mA
Total Power dissipation up to Tamb = 25°C	P_{tot}	300	mW
Operating And Storage Junction Temperature Range	T_j, T_{stg}	-55 to +150	°C
THERMAL RESISTANCE			
Junction to ambient	$R_{th(j-a)}$	420	K/W

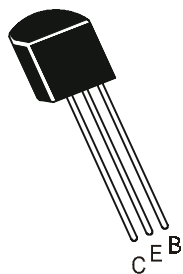
ELECTRICAL CHARACTERISTICS (Ta=25°C Unless Otherwise Specified)

DESCRIPTION	SYMBOL	TEST CONDITION	Min	Max	UNITS
Collector Cut- off Current	I_{CBO}	$V_{CB}=20V, I_E=0$		500	nA
Collector Cut - off Current	I_{CBO}	$V_{CB}=20V, I_E=0$ $T_a = 150\text{ }^\circ\text{C}$		4.0	μA
EmitterCut off Current	I_{EBO}	$V_{EB}=4V, I_C=0$		500	nA
Base Emitter Voltage	$V_{BE(ON)}$	$V_{CE}=10V, I_C=1\text{mA}$	0.65	0.74	V
DC Current Gain	h_{FE}	$I_C=1\text{mA}, V_{CE}=10V$			
	BF494		67	221	
	BF494A		200	500	
	BF494B		110	215	
	BF 495		35	125	
	BF 495C		65	135	
	BF 495D		40	85	

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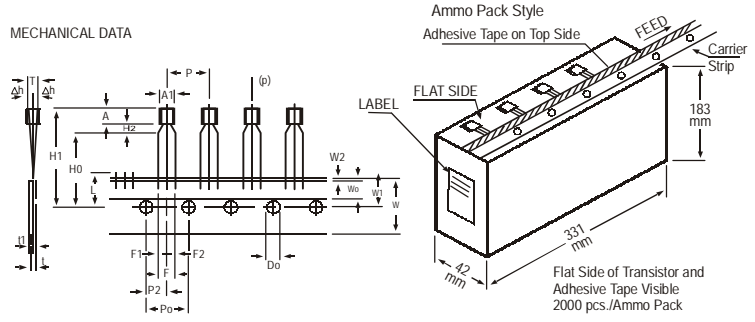
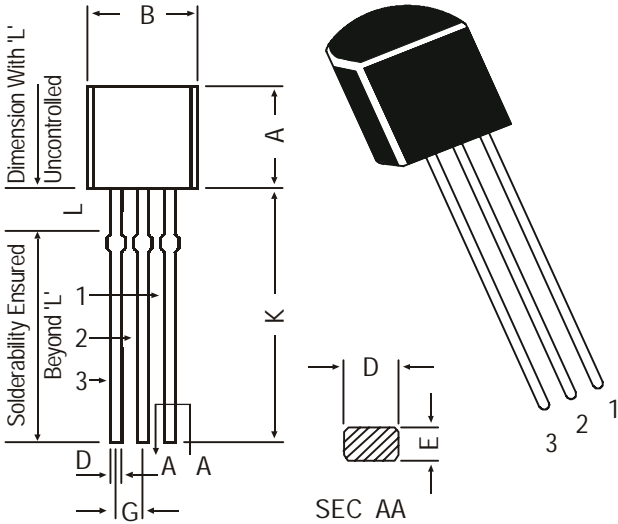
ELECTRICAL CHARACTERISTICS (Ta=25°C Unless Specified Otherwise)

DESCRIPTION	SYMBOL	TEST CONDITION	Min	Max	UNITS
DYNAMIC CHARACTERISTICS					
Transition Frequency	f_T	$I_C=1\text{mA}$, $V_{CE}=10\text{V}$	120		MHz
Feedback Capacitance	C_{re}	$V_{CE}=10\text{V}$, $I_C=1\text{mA}$ $f=4.5\text{MHz}$		1.0	pF

* V_{BE} decreases by about 1.7mV/K with increasing temperature.

TO-92 Plastic Package

TO-92 Transistors on Tape and Ammo Pack



All dimensions in mm unless specified otherwise

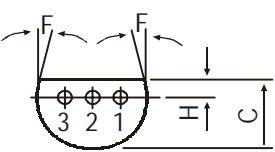
ITEM	SYMBOL	SPECIFICATION				REMARKS
		MIN.	NOM.	MAX.	TOL.	
BODY WIDTH	A1	4.0		4.8		
BODY HEIGHT	A	4.8		5.2		
BODY THICKNESS	T	3.9		4.2		
PITCH OF COMPONENT	P		12.7		±1	
FEED HOLE PITCH	Po		12.7		±0.3	
FEED HOLE CENTRE TO COMPONENT CENTRE	P2		6.35		±0.4	CUMULATIVE PITCH ERROR 1.0 mm/20 PITCH TO BE MEASURED AT BOTTOM OF CLINCH
DISTANCE BETWEEN OUTER LEADS	F		5.08		+0.6 -0.2	
COMPONENT ALIGNMENT	Δh		0	1		AT TOP OF BODY
TAPE WIDTH	W		18		±0.5	
HOLD-DOWN TAPE WIDTH	Wo		6		±0.2	
HOLE POSITION	W1		9		+0.7 -0.5	
HOLD-DOWN TAPE POSITION	W2		0.5		±0.2	
LEAD WIRE CLINCH HEIGHT	Ho		16		±0.5	
COMPONENT HEIGHT	H1			23.25		
LENGTH OF SNIPPED LEADS	L			11.0		
FEED HOLE DIAMETER	Do		4		±0.2	
TOTAL TAPE THICKNESS	t			1.2		±1 0.3 - 0.6
LEAD - TO - LEAD DISTANCE F1	F2		2.54		+0.4 -0.1	
CLINCH HEIGHT	H2			3		
PULL - OUT FORCE	(P)		6N			

NOTES

1. MAXIMUM ALIGNMENT DEVIATION BETWEEN LEADS NOT TO BE GREATER THAN 0.2 mm.
2. MAXIMUM NON-CUMULATIVE VARIATION BETWEEN TAPE FEED HOLES SHALL NOT EXCEED 1 mm IN 20 PITCHES.
3. HOLDDOWN TAPE NOT TO EXCEED BEYOND THE EDGE(S) OF CARRIER TAPE AND THERE SHALL BE NO EXPOSURE OF ADHESIVE.
4. NO MORE THAN 3 CONSECUTIVE MISSING COMPONENTS ARE PERMITTED.
5. A TAPE TRAILER, HAVING AT LEAST THREE FEED HOLES ARE REQUIRED AFTER THE LAST COMPONENT.
6. SPLICES SHALL NOT INTERFERE WITH THE SPROCKET FEED HOLES.

DIM	MIN.	MAX.
A	4.32	5.33
B	4.45	5.20
C	3.18	4.19
D	0.41	0.55
E	0.35	0.50
F	5 DEG	
G	1.14	1.40
H	1.14	1.53
K	12.70	—
L	1.982	2.082

All dimensions in mm.



PIN CONFIGURATION

1. BASE
2. EMITTER
3. COLLECTOR

Packing Detail

PACKAGE	STANDARD PACK		INNER CARTON BOX		OUTER CARTON BOX		
	Details	Net Weight/Qty	Size	Qty	Size	Qty	Gr Wt
TO-92 Bulk	1K/polybag	200 gm/1K pcs	3" x 7.5" x 7.5"	5K	17" x 15" x 13.5"	80K	23 kgs
TO-92 T&A	2K/ammo box	645 gm/2K pcs	12.5" x 8" x 1.8"	2K	17" x 15" x 13.5"	32K	12.5 kgs

Disclaimer

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